SQ2361CES

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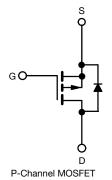
Automotive P-Channel 60 V (D-S) 175 °C MOSFET



FEATURES

- TrenchFET[®] power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





Marking Code: 9Wxxx

PRODUCT SUMMARY				
V _{DS} (V)	-60			
$R_{DS(on)}$ (Ω) at V_{GS} = -10 V	0.177			
$R_{DS(on)}$ (Ω) at V_{GS} = -4.5 V	0.246			
I _D (A)	-2.8			
Configuration	Single			

ORDERING INFORMATION Package SOT-23 Lead (Pb)-free and halogen-free SQ2361CES (for detailed order number please see www.vishay.com/doc?79771)

ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, unles	s otherwise noted	l)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-60	V	
Gate-source voltage		V _{GS}	± 20	v	
Continuous drain current	T _C = 25 °C	- I _D	-2.8		
	T _C = 125 °C		-1.6		
Continuous source current (diode conduction)		I _S	-2.5	А	
Pulsed drain current ^a		I _{DM}	-11		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	-12.5		
Single pulse avalanche energy	L = 0.1 IIIH	E _{AS}	7.8	mJ	
Maximum power dissipation	T _C = 25 °C	PD	2	W	
	T _C = 125 °C	гD	0.67	vv	
Operating junction and storage temperature ra	ange	T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount ^b	R _{thJA}	175	°C/W	
lunction-to-foot (drain)		R _{thJF}	75	0/10	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. When mounted on 1" square PCB (FR4 material)

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•	•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$		-60	-	-	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = -250 μA	-1.5	-	-2.5	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}	V _{GS} = 0 V V _{DS} = -60 V		-	-	-1	
		$V_{GS} = 0 V$	V _{DS} = -60 V, T _J = 125 °C	-	-	-50	μA
		$V_{GS} = 0 V$	$V_{DS} = -60 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	-150	
On-state drain current ^a	I _{D(on)}	$V_{GS} = -10 V$	$V_{DS} \le -5 V$	-10	-	-	Α
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = -10 V$	I _D = -2.4 A	-	0.130	0.177	Ω
		$V_{GS} = -10 V$	$I_D = -2.4 \text{ A}, \text{ T}_J = 125 \ ^\circ\text{C}$	-	-	0.310	
		$V_{GS} = -10 V$		-	-	0.320	
		V_{GS} = -4.5 V		-	0.205	0.246	
Forward transconductance ^b	9 _{fs}	V _{DS} =	= -10 V, I _D = -2 A	-	5	-	S
Dynamic ^b							
Input capacitance	C _{iss}	V _{GS} = 0 V	V _{DS} = -30 V, f = 1 MHz	-	380	550	pF
Output capacitance	Coss			-	50	75	
Reverse transfer capacitance	C _{rss}			-	30	42	
Total gate charge ^c	Qg			-	9	12	nC
Gate-source charge ^c	Q _{gs}	V _{GS} = -10 V V _{DS} = -30 V, I _D = -6	$V_{DS} = -30 \text{ V}, \text{ I}_{D} = -6 \text{ A}$	-	1.6	-	
Gate-drain charge ^c	Q _{gd}				3.3	-	
Gate resistance	R _g	f = 1 MHz		2.1	4.1	8.1	Ω
Turn-on delay time ^c	t _{d(on)}	V_{DD} = -30 V, R _L = 20 Ω I _D \cong -1.5 A, V _{GEN} = -10 V, R _g = 1 Ω		-	8	11	- ns
Rise time ^c	t _r			-	9	12	
Turn-off delay time ^c	t _{d(off)}			-	22	26	
Fall time ^c	t _f			-	4	6	
Source-Drain Diode Ratings and Charact	eristics ^b						
Pulsed current ^a	I _{SM}			-	-	-11	Α
Forward voltage	V _{SD}	I _F = -1.5 A, V _{GS} = 0 V		-	-0.9	-1.2	V
Body diode reverse recovery time	t _{rr}	I _F = -1.5 A, di/dt = 100 μs		-	23	46	ns
Body diode reverse recovery charge	Q _{rr}			-	25	50	nC
Reverse recovery fall time	ta			-	20	-	ns
Reverse recovery rise time	t _b			-	3	-	
Body diode peak reserve recovery current	I _{RM(REC)}			_	-2.89	_	А

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

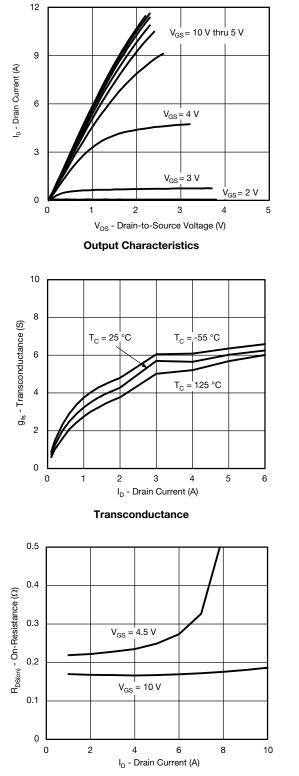
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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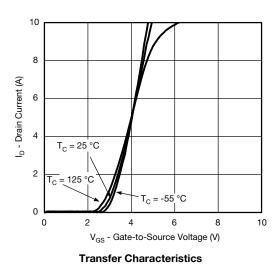


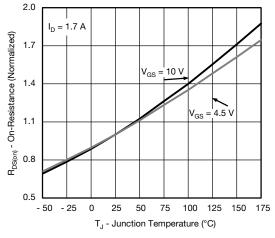
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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

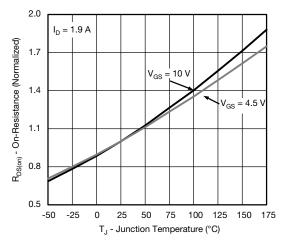


On-Resistance vs. Drain Current





On-Resistance vs. Junction Temperature



On-Resistance vs. Junction Temperature

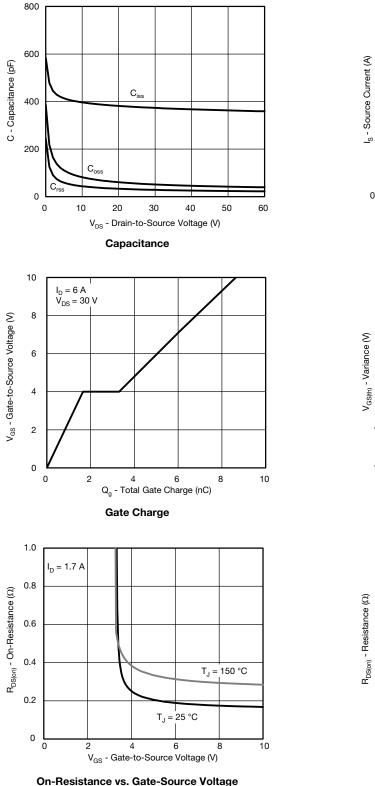
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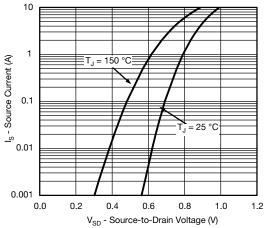


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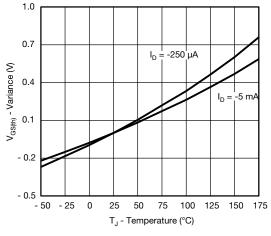
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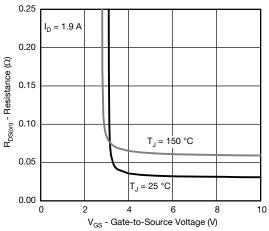




Source-Drain Diode Forward Voltage



Threshold Voltage



On-Resistance vs. Gate-Source Voltage

S23-0316-Rev. B, 15-May-2023

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Document Number: 62350

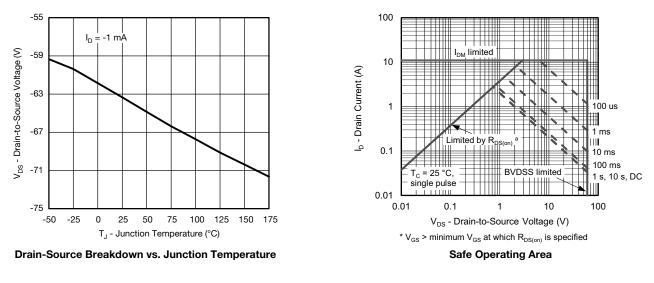
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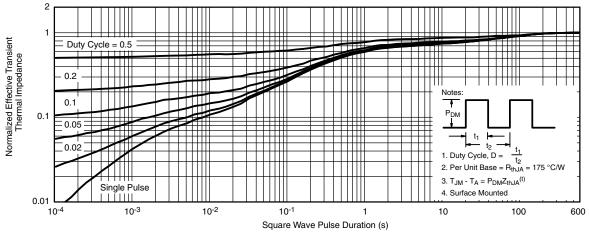


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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)





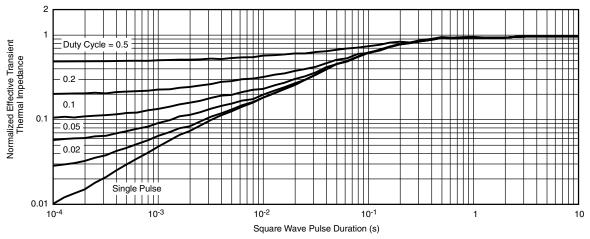
Normalized Thermal Transient Impedance, Junction-to-Ambient

S23-0316-Rev. B, 15-May-2023



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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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